Page 1 of 3

Docket No. 991131

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

| My residence, post offi | ce address and citize | enship are as stated below next to m | y name, |
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| first and joint inventor which a patent is sough AN ENHANCED SYSTEM | (if plural names are I ht on the invention er M FOR THE CREATIO RECIPIENTS THERE | entor (if only one name is listed below isted below) of the subject matter what the subject matter who it is the subject matter who it is the subject matter who is the subject of the sub | nich is claimed and for |
| the specification of whi | ch | | |
| (check one) | | | |
| is attached hereto. | | | |
| ☐ was filed on | | as United States Application No. | or PCT International |
| Application Numbe | r | | |
| and was amended | | | |
| | | (if applicable) | |
| • | | derstand the contents of the above i mendment referred to above. | dentified specification, |
| • | • | United States Patent and Trademarkity as defined in Title 37, Code of | |
| Section 365(b) of any any PCT International listed below and have | foreign application(s application which de- also identified below PCT International a | nder Title 35, United States Code, s) for patent or inventor's certificate signated at least one country other to, by checking the box, any foreign application having a filing date before | , or Section 365(a) of han the United States, pplication for patent or |
| Prior Foreign Application | on(s) | | Priority Not Claimed |
| PCT/US00/23454 | PCT | 25 August 2000 | |
| (Number) | (Country) | (Day/Month/Year Filed) | |
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| Prior Foreign Applica | luon(s) | | —————————————————————————————————————— |
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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